SFH 3100 F

Radial Mini Sidelooker

Silicon NPN Phototransistor with Daylight - Cutoff Filter





Applications

 Industrial Automation (Machine Controls, Light Barriers, Vision Controls)

Features:

- Package: black epoxy
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Spectral range of sensitivity: (typ) 850 ... 1100 nm
- Narrow half angle
- Small outline dimensions
- Same package as IRED SFH 4141
- High coupling factor in light barriers with SFH 4141
- Easy identification of SFH 3100 F (black package) and SFH 4141 (clear package)

Ordering Information

Туре	Photocurrent $V_{CE} = 5 \text{ V}; \lambda = 950 \text{ nm}; E_{e} = 0.5 \text{ mW/cm}^{2}$	Ordering Code
SFH 3100 F	¹ PCE 400 5000 μA	Q62702P5073
SFH 3100 F-2/3/4	630 3200 μA	Q62702P5475

Only one bin within one packing unit (variation less than 2:1)



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T,	=	25	$^{\circ}C$
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Parameter	Symbol		Values
Operating temperature	T _{op}	min.	-40 °C
	ор	max.	85 °C
Storage temperature	T _{stg}	min.	-40 °C
	sig	max.	85 °C
Collector-emitter voltage	V _{CE}	max.	35 V
Collector current	I _c	max.	50 mA
Collector surge current	I _{cs}	max.	100 mA
T ≤ 10 μs			
Emitter-collector voltage	$V_{\sf EC}$	max.	7 V
Total power dissipation	P_{tot}	max.	150 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V _{ESD}	max.	2 kV



Characteristics

T_A = 25 °C

Parameter	Symbol		Values
Wavelength of max sensitivity	$\lambda_{_{S\;max}}$	typ.	920 nm
Spectral range of sensitivity	λ _{10%}	typ.	850 1100 nm
Chip dimensions	LxW	typ.	0.55 x 0.55 mm x mm
Radiant sensitive area	А	typ.	0.11 mm²
Half angle	φ	typ.	14 °
Dark current V _{CE} = 20 V; E = 0	I _{CE0}	typ. max.	1 nA 50 nA
Rise time $I_c = 1 \text{ mA}$; $V_{cc} = 5 \text{ V}$; $R_L = 1 \text{ k}\Omega$	t _r	typ.	7 µs
Fall time $I_c = 1 \text{ mA}$; $V_{cc} = 5 \text{ V}$; $R_L = 1 \text{ k}\Omega$	t _f	typ.	9 µs
Collector-emitter saturation voltage 1) Threefold saturated	V _{CEsat}	typ. max.	140 mV 400 mV
Capacitance $V_{CE} = 5 \text{ V}; f = 1 \text{ MHz}; E = 0$	C _{CE}	typ.	4 pF
Capacitance $V_{CE} = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	C_{\scriptscriptstyleCE}	typ.	7.5 pF
Thermal resistance junction ambient real	R_{thJA}	max.	280 K / W



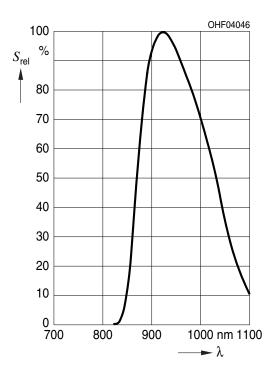
Grouping

 $T_A = 25$ °C

Group	Photocurrent $V_{CE} = 5 \text{ V}; \lambda = 950 \text{ nm}; E_e = 0.5 \text{ mW/cm}^2 \text{ min.}$ I_{PCE}	Photocurrent $V_{CE} = 5 \text{ V}; \lambda = 950 \text{ nm}; E_{e} = 0.5 \text{ mW/cm}^{2}$ max. I_{PCE}
1	400 μΑ	800 μΑ
2	630 μΑ	1250 μΑ
3	1000 μΑ	2000 μΑ
4	1600 μΑ	3200 μΑ
5	2500 μΑ	5000 μΑ

Relative Spectral Sensitivity 2), 3)

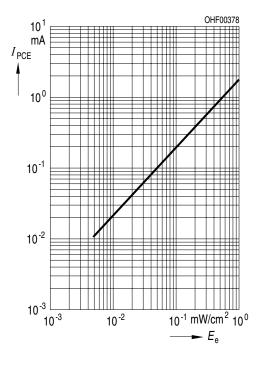
$$S_{rel} = f(\lambda)$$





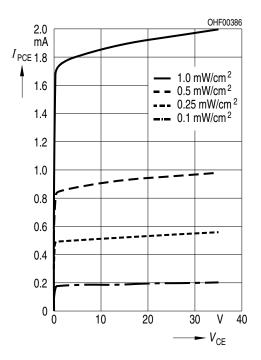
Photocurrent ^{2), 3)}

$$I_{PCE} = f(E_e)$$
; $V_{CE} = 5 V$



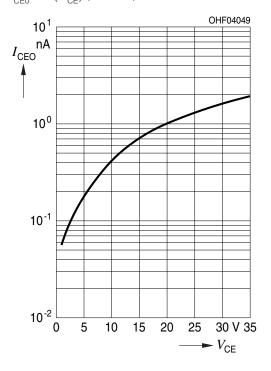
Photocurrent 2), 3)

$$I_{PCE} = f(V_{CE}), E_{e} = Parameter$$



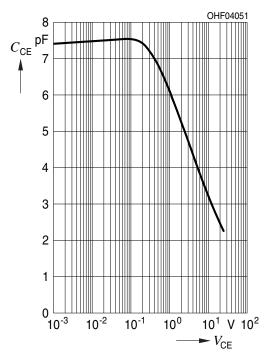
Dark Current 2), 3)

$$I_{CE0} = f(V_{CE}); E = 0;$$



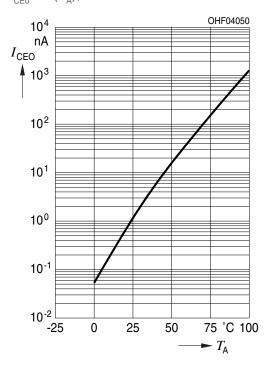
Collector-Emitter Capacitance 2), 3)

$$C_{CE} = f(V_{CE}); f = 1 MHz; E = 0;$$



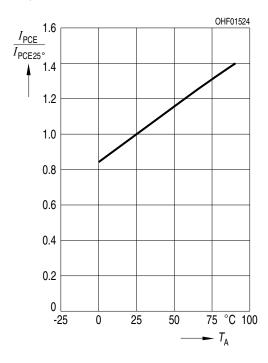
Dark Current 2)

$$I_{CE0} = f(T_A); E = 0$$



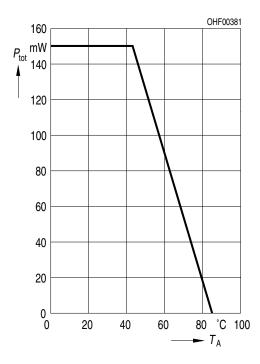
Photocurrent 2)

$$I_{PCE,rel} = f(T_A); V_{CE} = 5 V$$



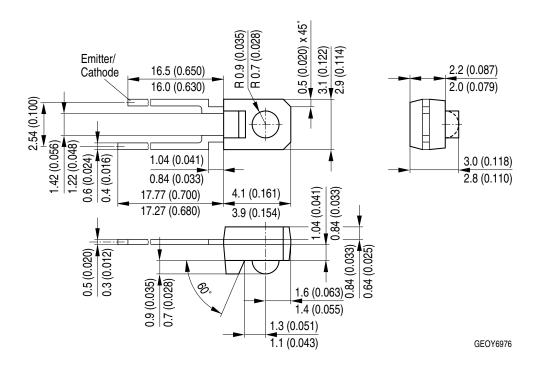
Power Consumption

$$P_{tot} = f(T_A)$$





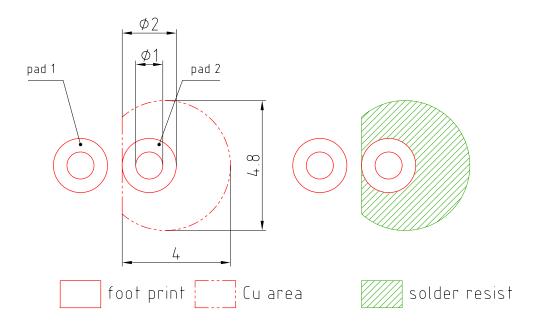
Dimensional Drawing 4)



Approximate Weight: 156.0 mg

Package marking: Collector

Recommended Solder Pad 4)

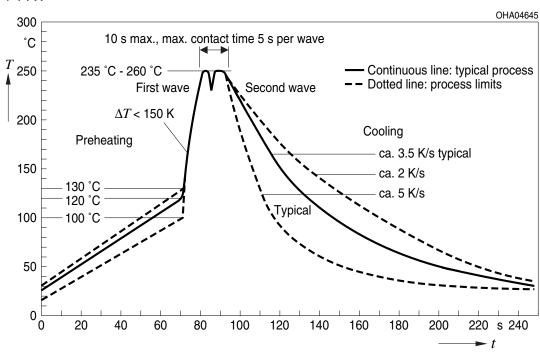


E062.3010.188-01

Pad 1: emitter

TTW Soldering

IEC-61760-1 TTW





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes



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Glossary

- $^{1)}$ **IPCEmin**: I_{PCEmin} is the min. photocurrent of the specified group.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Testing temperature: $T_A = 25^{\circ}C$
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.



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